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Improving Man's Effectiveness Through Electronics

Model 990 Computer PROM Programming Module Installation and Operation

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PREFACE

This manual provides detailed instructions for installing the Texas Instruments PROM Programming Module in conjunction with a Model 990 Computer System. In addition, it contains information required to program the computer to use the line printers, and a description of the units, with specific attention to the controls and indicators. The information is divided into the following four sections:

- I General Description Briefly describes the features and major components of the line printer subsystem to acquaint the reader with this subsystem.
- II Installation Provides step-by-step instructions for unpacking and installing the line printers in either a local or remote location.
- III Programming Presents interfacing information for use by a programmer in designing a service routine to control the line printer's activity.
- IV Operation Describes the controls and indicators of the line printers for operators. It includes line printer information as well as line printer status and maintenance indicators so that the operator can determine that the line printers are operating properly.

If you would like one of Texas Instruments' service personnel to install the programming module for you, please contact your Texas Instruments Sales or Service Offices. These offices can also obtain additional information concerning the module, if you should decide to perform the maintenance on the equipment.

The following related publications contain information about the programming module in conjunction with the 990 computer systems.

Title	Part Number
Model 990/4 Computer System Depot Maintenance Manual. Contains test bench setup and assembly repair in- structions which apply to the PROM Programmer Module.	945403-9701
Model 990 Computer 733 ASR/KSR Terminal Installation and Operation. Provides information needed to oper- ate the ASR/KSR Terminal when run- ning the diagnostic program.	945259-9701
Model 990 Computer Diagnostic Handbook. This manual contains instructions for using the diagnos- tic software for the PROM Program- mer Module.	9 45400- 9701

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Model 990 Computer Family Maintenance Drawings. Contains schematics and assembly drawings for the PROM Programmer Module.

Model 990 Computer PROM Programming Module Depot Maintenance. This manual provides information for component repair in the PROM programming module. Part Number

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SECTION I

GENERAL DESCRIPTION

1.1 GENERAL

The PROM Programming Module (Part Number 944924) is a software controlled device that allows creation of custom ROMs from commercially available programmable read-only-memory circuits (PROMs). The module consists of a chassis, one or more personality cards, a CRU interface and control module, and a flat ribbon cable that connects the chassis to the interface module. Figure 1-1 illustrates the module kit. Designed to combine dependable performance with ease of use, the module incorporates the following features:

- Interchangeable personality cards for programming either fusible link bi-polar PROMs or Erasable PROMs
- Positive locking sockets hold the PROM firmly in place during programming cycle
- Six software selectable programming pulse widths to adapt to PROM requirements
- Addressing capability for 4K 8-bit PROM words
- Chassis can be mounted in a 19-inch rack or with optional housing can become an attractive, desk-top module.

1.2 SYSTEM TERMINOLOGY

Figure 1-2 illustrates the relationship of the major components of the programming module. The following paragraphs provide an overview of the interaction of these components. More detailed information about the internal operation of the module components can be obtained in The Model 990 Computer PROM Programming Module Depot Maintenance Manual.

1.2.1 COMMUNICATIONS REGISTER UNIT (CRU). The Communications Register Unit (CRU) is the serial interface of the Texas Instruments Model 990 Computer. Data is transmitted between the controller and the computer through this interface one bit at a time, requiring eight data transfers for each 8-bit ROM word. Control information, such as address and pulse widths for the PROM, are also transmitted to the controller through this interface.

1.2.2 PROM PROGRAMMER CONTROL CARD. The control card contains all the control and interface electronics required to operate the programming module in conjunction with a Model 990 Computer. The module normally installs in the bottom front slot of the chassis, but it may occupy any available CRU slot of the computer. Included on the circuit board are an input register, an address register, a data register, a pulse width register, plus control circuitry to coordinate the programming cycle. The input register converts the serial input from the CRU interface into parallel data for loading into one of the other registers or for control information. See Section III of this manual for the disposition of the bits in this register. The address register is a 12-bit register that supplies address information to the PROM to be programmed. The value in this register must be changed each time a new word is entered into the PROM. The data register is an 8-bit register that holds the value to be entered into the ROM word addressed by the address register. The pulse width register is a 6-bit register that holds control bits to select one of the six available pulse widths to be used during the programming cycle. Only one bit of

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Figure 1-2. PROM Programming Module System Block Diagram

the pulse width register should be set at any one time. Section III of this manual provides the details required to select the desired pulse width.

Control logic on the control card monitors the input control bits in the input register and initiates a programming cycle at the direction of the computer. During the programming cycle, the control logic provides the required gates to apply a voltage to the PROM to program the specified data in the addressed area in the PROM. Feedback logic on the control card allows the computer to sample the contents of the three parameter registers (address, data and pulse width), to read the contents of the addressed ROM location, or to monitor the status of the programming module.



Two personality cards are available for use with the programming module. One personality card is used for bipolar PROMs and the other personality card is used for EPROMs. Table 1-1 lists the device types accepted by each personality card together with the characteristics of the devices. The personality cards are contained in a unitized assembly that includes the front panel of the programming module chassis. Replacement of the personality card can be performed quickly and easily.

$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	Personality							
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Pulse width ranges specified by device manufacturer Each PROM word must be pulsed several times. Puls must be applied to a particular PROM word for succ $N(t_{pw}) \ge 100$ milliseconds where N is the number of loops and t_{am} is the pulse		MOS 2708	1024 x 8	1	N/A		o.1 to 1.0 milli- seconds ²	MOS, reprogrammable
Each PROM word must be pulsed several times. Puls must be applied to a particular PROM word for succ $N(t_{pw}) \ge 100$ milliseconds where N is the number of loops and t_{am} is the nulse	¹ Pulse width ran	iges specified by de	vice manufacturers					
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SECTION II

INSTALLATION

2.1 GENERAL

This section provides information for planning the installation site, unpacking and packing the module, installing the module and its interface card at the site, and ensuring that the module is installed and operating properly. The instructions in this section require a moderate familiarity with cabling technique and use of common handtools, but do not assume any level of expertise in digital electronics.

2.2 SITE REQUIREMENTS

The PROM Programmer may be installed either as a desk-top unit or in a 19-inch rack-mounted configuration. Figures 2-1 and 2-2 illustrate the physical size of each of the configurations. An additional clearance of approximately 3 inches (7.6 cm) should be maintained on all sides of the desk-top unit to allow for cooling air flow. Table 2-1 lists the requirements of the PROM Programmer that affect planning for the installation site.



Figure 2-1. PROM Programmer Rack Mounted Dimensions

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Characteristic	Requirement
Power	
Interface Card	0.8 amps (maximum) of +5 vdc logic voltage (supplied by computer chassis)
Programmer	0.6 amps (maximum) of 115 vac, +15%, -10%, or 0.7 amps (maximum) of 100 vac, +15%, -10%, or 0.3 amps (maximum) of 230 vac, +15%, -10%
Temperature	
Operating	32 to 152 degrees F (0 to 65 degrees C)
Storage	-40 to 158 degrees F (-40 to 70 degrees C)
Humidity	0 to 95% without condensation
Cable length	
Power cord	6 feet from Programmer to ac power source
Interface cable	12 feet (3.6 m) from Programmer to interface card in computer chassis

Table 2-1. PROM Programmer Physical Characteristics

2.3 UNPACKING/PACKING

The PROM Programmer is shipped in a corrugated cardboard container as illustrated in figure 2-3. If included as part of a computer system shipment, the interface board is shipped in the computer chassis. If the PROM Programmer is shipped alone, the interface board is wrapped in bubble-pack and included in the same carton as the PROM Programmer. The programming module is shipped fully assembled with the personality card (if ordered) installed on the front of the PROM Programmer. If a second personality card is included in the shipment, it is wrapped in bubble-pack and included in the same carton as the PROM Programmer. Interface cables are shipped with the personality card.

Upon receipt of the shipping container, inspect it to ensure that there is no physical damage. After this preliminary inspection, perform the following steps to remove the PROM Programmer components from the shipping container and ready them for installation in the computer system. Figure 2-4 illustrates the system components that are packed in the shipping container.

NOTE

Save shipping container and all packing material for use in reshipment.

- 1. Position the shipping container so that the address label is right-side up.
- 2. Open the top of the container and remove the packet containing the documentation for the PROM Programming system, the packet containing the interface circuit board (if system is shipped separately), and the packet containing the extra personality card (if ordered).
- 3. Carefully remove packing material from extra personality card (if extra card is included in shipment), and set personality card in a safe place.

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Figure 2-3. PROM Programmer Shipping Container

- 4. Remove the packing assembly from the shipping carton (packing assembly includes cushioning material and PROM Programmer) and place assembly on a table or desk.
- 5. Remove cushioning material from PROM Programmer and set programmer on the table.
- 6. Ensure that no physical damage is apparent to the PROM Programmer, the interface circuit board or the extra personality card.
- 7. Replace all packing material into the shipping container and store container for future reuse.

To repack the unit for shipment, perform the unpacking procedure in reverse order. Reseal the shipping container with filament reinforced tape.

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Figure 2-4. PROM Programmer Kit Component

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2.4 INSTALLATION OF PROM PROGRAMMER (TABLETOP)

Perform the following steps to install the tabletop model of the PROM Programmer at the site selected for it:

1. Remove front panel/personality card assembly from the programmer by pulling the front panel assembly out from the programmer.

2. Ensure that the personality card is correct for the PROM devices to be used (TTL PROM card has three sockets; EPROM card has one socket).

CAUTION

Improper alignment of interface cable connector could result in damage to interface module circuits and/or PROM Programmer circuits.

- 3. Connect the flat ribbon interface cable to the personality module by first aligning the triangle indicator on the cable connector with the matching indicator on the personality module connector, and firmly seating the two connectors together. (Refer to figure 2-5.)
- 4. Ensure that the logic power and the ac power connectors from the interior of the PROM Programmer are properly connected to the personality card.
- 5. Replace front panel/personality card assembly on the front of the programmer by first aligning the panel with the sides of the programmer chassis and then pressing on the front panel to mate it to the chassis.
- 6. Place the programmer in the desired location.
- 7. Remove the cable tie from the ac power cord at the rear of the programmer. Connect the power cord to the grounded receptacle for applicable electrical power (either 100 vac, 115 vac or 230 vac; 50 or 60 Hz). Do not turn the programming module on at this time.

2.5 INSTALLATION OF PROM PROGRAMMER (RACKMOUNT)

The rackmounted version of the PROM Programmer occupies 7 inches of vertical space in the rack. It is mounted to the rack by two bolts on either side that fit into predrilled holes in the rack. The mounting holes for the programmer are 4 inches apart. The following steps describe the procedure for mounting the programmer in a 19-inch rack:

- 1. Remove the front panel/personality card assembly from the programmer by pulling the front panel assembly out from the programmer.
- 2. Disconnect ribbon cable, logic power and ac power connectors from front panel assembly and set front panel assembly aside.
- 3. Select two mounting holes in the vertical rack on one side that are four inches apart and equally spaced within the 7 inch vertical space reserved for the PROM Programmer. Insert one mounting bolt in each of the two mounting holes. Turn bolts to start threads into holes.

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- 4. Engage slots in mounting flange of programmer on the bolts inserted in step 3 so that the bolts support the weight of one end of the programmer.
- 5. Align slots in mounting flange on opposite side of programmer with holes in rack. Insert and tighten two mounting bolts to secure the second side.
- 6. Tighten the first two bolts to completely secure the programmer to the rack.
- 7. Ensure that the personality module is correct for the PROM devices to be used (TTL PROM personality module has 3 sockets; EPROM personality module has 1 socket).

CAUTION

Improper alignment of interface cable connector could result in damage to interface module circuits and/or PROM Programmer circuits.

- 8. Connect the flat ribbon interface cable to the personality module by first aligning the triangle indicator on the cable connector with the matching indicator on the personality module connector, and firmly seating the two connectors together. (Refer to figure 2-5.)
- 9. Connect the logic power and ac power connectors from the interior of the PROM Programmer to the connectors on the personality card (these connectors were removed in step 2).
- 10. Replace the front panel/personality card assembly on the front of the programmer by aligning the panel with the sides of the programmer chassis and then pressing on the front panel to mate it to the chassis.
- 11. Remove the cable tie from the ac power cord at the rear of the programmer. Connect the power cord to a grounded receptacle for applicable electrical power (either 100 Vac, 115 Vac or 230 Vac; 50 or 60 Hz). Do not turn the programming module on at this time.

2.6 CONNECTION TO COMPUTER

The programmer interface module is a plug-in circuit board that serves as an interface between the computer and the PROM Programmer. This module (part number 944925-0001) can be installed in a CRU connector in the computer chassis, or in an expansion chassis connected to the computer. In all cases, the computer and/or the expansion chassis equipment must be installed and operating properly. Refer to the computer hardware reference manual listed in the Preface for installation procedures for this equipment.

2.6.1 LOCATION OF INTERFACE MODULE. The assigned location of the interface module, whether installed in the computer chassis or the expansion chassis, determines the CRU address to which it responds. Conversely, the CRU address which the system software expects determines the chassis location of the interface module. The standard location for the interface module in the computer is slot 13 in the 13-slot chassis and slot 6 in the 6-slot chassis. In both cases the CRU base address is 0020_{16} (front half of the slot) and the interrupt level is 15. The standard configuration for the computer chassis connects this CRU slot to interrupt level 15. If the interface module is installed in any other location than slot 13 or slot 6, then the interrupt level compatible with the new address, and then reinstalled. However, TI supplied software for the

PROM Programmer (PROMPG) disables the interrupt on the module (interrupt is generated at completion of one programming cycle), so that allowance for an interrupt is only required if user-supplied software depends on the interrupt. For instructions to modify an interrupt level, refer to either the Model 990/4 Computer System Hardware Reference Manual, part number 945251-9701, or the Model 990/10 Computer System Hardware Reference Manual, part number 945417-9701.

2.6.2 INSTALLING THE INTERFACE MODULE. Once the proper location for the interface module has been determined, the module can be installed in the computer or in the expansion chassis and connected to the flat ribbon cable. Refer to figure 2-5 for an interconnection cabling illustration. To install the interface module and connect the PROM Programmer, perform the following steps.

1. Set the POWER switch on the back of the computer or expansion chassis to the OFF position.

NOTE

The interface module circuit board has two plastic, pivoted tabs (board ejectors) on one end of the board. This is the outside edge of the board; the opposite edge inserts into the connector in the computer chassis.

2. Insert the interface module circuit board (part number 944925-0001) into the chassis location corresponding to the desired address. Ensure that the component side of the circuit board is facing upward and the slots in the circuit board mate properly with the alignment comb on the backplane connector.





CAUTION

Improper alignment of interface cable connector could result in damage to interface module circuits and/or PROM Programmer circuits.

- 3. Connect the flat ribbon interface cable (part number 945019-0001) to the connector of the interface module. Ensure that the embossed triangle on the cable connector is aligned with the matching triangle on the interface board connector. The cable dresses down from the interface board.
- 4. Route the cable out through the rear of the computer chassis.
- 5. Apply power to the computer, expansion chassis and PROM Programmer.

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PROGRAMMING

3.1 GENERAL

This section provides information required to generate a program that interfaces a member of the 990 Computer Family to the PROM Programming Module. This section assumes that the user is experienced in using 990 Computer Assembly Language as described in the *Model 990 Computer TMS9900 Microprocessor Assembly Language Programmer's Guide*, part number 943441-9701. In addition, the examples in this section assume that the user has established the format of the data to be stored in a PROM circuit, and that the data is stored in a known area of memory. The information in this section applies only if the user has not elected to use the software interface to the module (PROMPG) included in the Prototyping System Software. For information regarding use of the PROM Programming Module with the Prototyping System, refer to the *Model 990 Computer Prototyping System Operation Guide*.

3.2 CRU INTERFACE

The PROM Programming Module is controlled through manipulation of specified bits of the Communications Register Unit (CRU) interface of the 990 Computer. The module is assigned 16 bit addresses within the CRU. Each bit address can be used to transfer information either to or from the module using the appropriate bit transfer (SBZ, SBO, TB) or register transfer (STCR, LDCR) instructions of the computer. Although the base address of the module varies with the location of the module within the computer chassis, the displacement address assignments remain constant. Figure 3-1 illustrates the bit address assignments for the module during both an input and an output operation. Table 3-1 defines the output bit assignments; table 3-2 defines the input assignments. The programming examples in this section assume that the module interface card is installed in the bottom front chassis location and responds to CRU base address 0020₁₆.

3.3 PROM PROGRAMMING

The software interface between the computer and the module must perform five basic operations to transfer data from a location in computer memory to the desired bit pattern in the PROM circuit. These five operations are:

- 1. Establish the ROM word address of the area in the PROM device.
- 2. Transfer the data to be stored in the PROM to the module.
- 3. Specify the duration of the programming pulse used to implant the data in the PROM.
- 4. Initiate the programming cycle.
- 5. Time the programming cycle and delay the next cyle to allow for duty cycle restrictions on a TTL PROM device.

The following paragraphs describe a method for performing these operations. This method is intended for illustrative purposes only, and may not be the best or most efficient means of performing the step for a particular application.

3-1





3-2

Table 3-1. PROM Programmer CRU Interface Output Bit Assignments

Base Relative Bit Number (Hexadecimal)				Description	
00 Through 07	Address	Reg	ister, t	ht bits of data to be loaded he PROM Data Register, or d by the Register Select Co	the Pulse Width
' 08 Through 0A	register o	of th to I	e data	<i>de:</i> A 3-bit code that specif in Output Bits 0 - 7, or the Bits 0 - 7. The codes select s	source of data to be
	_8	9	A	Output Destination	Input Source
0B,0C 0D	0 1 0 1 0 1 Not Used <i>Load Sp</i> Data fro Register	0 0 1 0 0 1 1 1 d d Selo	0 0 0 1 1 1 1 1 1 3 <i>ied Re</i> vits 0-7 ect Co	PROM Addr 0-3 (MSB) PROM Addr 4-11 No Assignment PROM Data 0-7 No Assignment Pulse Width 1-6 No Assignment No Assignment Seister: When this bit is set is transferred to the regis de. The selected register lo Register Data byte.	PROM Addr 0-3 (MSB) PROM Addr 4-11 No Assignment PROM Data 0-7 No Assignment Pulse Width 0-5 No Assignment PROM Read 0-7 to a "1", the Register ter specified by the
0E	<i>Interrup</i> When th	<i>ot Er</i> uis b	<i>able:</i> it clea	Setting this bit to a "1" e rs, the interface module is	
0F	erating an interrupt to the computer. GO: Setting this bit to a "1" instructs the programming module to begin a programming cycle using the data, address and pulse width currently contained in the interface registers. When one programming cycle is complete, the module generates an inter- rupt to the computer if the Interrupt Enable bit is not clear.				

3.3.1 PROM ADDRESS. The module interface card contains a 12-bit address register for providing address data to the PROM device that is being programmed. Before programming the device, this register must be loaded using the Register Data bits of the CRU interface with the module. Since only eight Register Data bits can be transferred with one CRU operation, loading the address register requires two CRU data transfers: one transfer to load the most significant four bits of the address register, and one transfer to load the least significant eight bits of the address register. Each transfer consists of 3 CRU operations: an LDCR instruction to transfer the address value and register select bits to the module (where it is held in an input register), an SBO instruction to set the Load Specified Register bit, and an SBZ instruction to clear the Load Specified Register bit (bit 13).

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	Bit Assignments
Base Rel ative Bit Number (Hexadecimal)	Description
00 (LSB) Through 07 (MSB)	Selected Data: Eight bits of data that provide diagnostic feedback, status indications, or read data from the addressed PROM. Contents of these input bits are determined by the Register Select Code (Output Bits 8-A) from the computer.
08 Through OB	These bits are not currently assigned
0C	<i>Fault:</i> When set, this bit indicates an equipment failure has occurred in the PROM Programmer system. This bit is not currently implemented.
0D	<i>Timing Error:</i> When set, this bit indicates that the GO bit (output bit F) was reset during the current PROM programming cycle. Timing error clears at the end of the cycle.
0E	Online: When this bit is a logic zero, it indicates that the interface module is plugged into the computer or expansion chassis and is receiving logic voltage from that chassis.
0F	Busy: When set, this bit indicates that the module is currently in the programming mode. When this bit is set, any attempt to clear the GO bit will not end the programming cycle, but will clear the GO bit and set the Timing Error bit.

 Table 3-2. PROM Programmer CRU Interface Input

 Bit Assignments

For example, loading the 12-bit PROM address $A73_{16}$ into the module address register requires the following instruction sequence:

ADDRO	BYTE	>01	Initial Register Select Code
ROMAD1	BYTE	>73	Least Significant Byte of
			ROM Address
ROMAD2	BYTE	>0A	Most Significant Byte of
			ROM Address
PRMBA	DATA	>20	Module Base Address
START	MOV	@PRMBA, R12	Transfer Base Address to
			Workspace Register 12
	MOVB	@ROMAD1,R1	Transfer Least Significant Byte
			of ROM Address to R1
	SRL	R1,8	Shift ROM Address to Least
			Significant Byte of R1
	MOVB	@ADDR0,R1	Transfer Register Select Code to
			Most Significant Byte of R1

(Listing continued on next page)

Change 1

	LDCR	R1,0	Transfer (R1) to module input register
	SBO	13	Set Load bit; transfers address from input register to address register bits 4-11
	SBZ	13	Clear Load bit
NXTAD	MOVB	@ROMAD2,R1	Transfer Most Significant Byte of ROM Address to R1
	SRL	R1,8	Shift ROM Address to Least Significant Byte of R1
	CLR	RO	Change Register Select Code to 000016
	MOVB	R0,R1	Transfer Register Select Code to Most Significant Byte of R1
	LDCR	R1,0	Transfer (R1) to module input register
	SBO	13	Set Load bit; transfers address from input register to address register bits 0-3 (bits 0-3 of address byte 0A ₁₆ are ignored)
	SBZ	13	Clear Load bit

3.3.2 DATA TRANSFER. Once the ROM address has been set-up in the module, the data register must be loaded with the byte of data to be stored in the PROM circuit. This sequence is similar to transferring the address, except that the register select code bits are different. The following instruction sequence transfers the value FF_{16} from a location in memory to the module for storage in an EPROM device. Because each EPROM word must be programmed repeatedly, this sequence must be repeated several times for each word. Refer to EPROM data sheets for specific requirements.

MEMADD	EQU DATA	\$ >00FF .	Establish memory address for data Enter data in memory location MEMADD
DATAIN	BYTE	>03	Register Select Code to load data
START	MOV	@MEMADD,R1	Transfer data from memory address MEMADD to R1
	MOVB	@DATAIN,R1	Transfer Select Code (Left byte) to R1 (left byte)
	LDCR	R1,0	Transfer (R1) to module input register
	SBO	13	Set Load bit, transfers data from input register to PROM
	SBZ	13	Data register. Clear Load bit

TTL PROMs must be programmed one bit at a time and, therefore, require a masking operation prior to transferring data to the PROM Programmer. Data masking is discussed later in this section. ŝ



3.3.3 PULSE WIDTH. The duration of the programming pulse required for a particular PROM device is specified by the manufacturer of the device being used. To accomodate a variety of PROM devices, the module allows the user to select one of six available pulse widths to be used during the PROM programming cycle. The selection of pulse width is accomplished by setting one of the bits in the Pulse Width Register of the module. To ensure that the correct bit is set, load all of the bits in the Pulse Width Register each time. Table 3-3 lists the hexadecimal values that can be loaded into the register and the corresponding pulse widths produced.

The instruction sequence to transfer the selected register value to the module is similar to the previous two transfers. Again, the register select code value is different. The following sequence transfers the value to select a pulse width of 2.0 milliseconds to the module:

PSWD	EQU	\$	Establish memory address for pulse width value
	DATA	>0004	Enter value corresponding to 2.0 milliseconds
PWD	BYTE	>0500	Register Select Code for pulse width
START	MOV	@PSWD,R1	Transfer value from memory address PSWD to R1.
	MOVB	@PWD,R1 、	Transfer select code (left byte) to R1 (left byte)
	LDCR	R1,0	Transfer (R1) to module input register
	SBO	13	Set Load bit; transfers data from input register to Pulse
	SBZ	13	Width Register Clear Load bit.

Table 3-3. Programming Pulse Widths

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Value in Memory (Hexadecimal)	Pulse Width (Milliseconds)	
0001	0.5	
0002	1.0	
0004	2.0	
0008	4.0	
0010	8.0	
0020	16.0	

Change 1

3.3.4 INITIATE PROGRAMMING CYCLE. Once all of the module registers contain the desired parameters, the programming cycle can begin. Before starting, however, the status of the module should be checked to ensure that it is capable of performing the operation. In addition, the interrupt line from the module should be disabled unless the software interface is designed to handle the interrupt. The following instruction sequence checks module status and then instructs the module to begin the programming cycle:

ТВ	15	Check Online- bit
JEQ	ONLERR	If device is not online (Online- =1), then jump to user defined routine, ONLERR
SBZ	14	Disable interrupts
SBZ	15	Ensure that the Go bit is clear
SBO	15	Set Go bit; starts programming cycle

3.3.5 DUTY CYCLE TIMING. TTL PROM devices require a rest period between programming cycles to allow their internal circuits to cool and stabilize. Failure to allow for this rest period will produce unreliable results. EPROM circuits require no extended rest period. The duration of the rest period is determined by the duty cycle parameter specified for the particular device. Duty cycle is expressed as a percentage of the programming cycle time to the total of programming and rest times. A duty cycle of 25 percent, for example, indicates that there must be a rest period 3 times longer than the programming cycle between each programming cycle. The software interface for the module must ensure that the duty cycle requirement is met.

A set of counting loops can ensure that a sufficient rest period is allowed. Begin the first counting loop when the Go bit is set, and then monitor the Busy bit to determine when the programming cycle stops. When Busy clears, the count from the first loop can be multiplied by a factor (determined by the duty cycle parameters) to arrive at the number of counts required to satisfy the rest period. The following sequence satisfies the time keeping requirements to ensure dependable PROM programming results:

MAXCT	EQU	65000	Define upper bound for count operation
	CLR	R14	Clear R14 for use as counting register
LOOP	EQU	\$	Begin timing loop
	ТВ	15	Check Busy bit
	JNE	CONTIN	If not busy, exit loop to CONTIN
	INC	R14	Add one to counting register, R14
	CI	R14,MAXCT	Compare count with upper bound
	JGT	HWERR	If R14 exceeds upper bound, jump to error routine HWERR
	JMP	LOOP	Return to start of count loop
CONTIN	EQU	\$	Begin rest period time calculation
	SBZ	15	Clear Go bit

(Listing continued on next page)

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L.	945258-	9701		
U	DTYCY	EQU LI	0025 R11,DTYCY	Define a 25% duty cycle Transfer duty cycle value to R11
		LI S	R0,100 R11,R0	Load a value of 100 into R0 Subtract duty cycle value from 100; remainder stored in R0
		MOV CLR	R0,R1 R1	Right justify remainder in R0 and R1
		DIV	R11,R0	Divide value in R0 and R1 by duty cycle value; result stored in R0, remainder in R1
ų.		MOV JEQ INC	R1,R1 GOON R0	Compare remainder to zero If remainder is zero, jump to GOON If remainder is not zero, add one to R0 to round up the count.
	GOON	ΕΩU ΜΡΥ	\$ R14,R0	Multiply programming time (R14) by rest time multiplier contained in R0 and R1; answer stored in R0 and R1, right justified.
mx	NXTLP	CI JEQ EQU DEC NOP	R1,0 OUTLP \$ R1	Compare R1 to zero If R1=0, jump to next comparison If R1≠0, begin rest time count loop Subtract 1 from value in R1 No-op instructions to match delay time in first loop
	OUTLP	JH EQU CI JEQ DEC	NXTLP \$ RO,O OUT RO	If R1 is greater than zero, repeat loop Compare R0 to zero If R0 is zero, jump to exit routine, OUT If R0 is not zero, decrement R0
		JMP	NXTLP	Repeat loop (until R0 and R1 are zero)

3.4 DATA MASKING

TTL PROM devices must be programmed in a bit-by-bit fashion. Attempts to program more than one bit at a time produce unreliable results. Therefore, when programming the PROM Programmer for TTL PROMs, all but one of the PROM word bits must be masked to the inactive level during a particular programming cycle. This restriction requires four separate programming cycles to program each 4-bit PROM word (or eight cycles to program an 8-bit PROM word). The following instruction sequence illustrates the data manipulation within the computer that is required to program a 4-bit PROM word. The example assumes that the PROM Programmer stores ones in the PROM (initial state of the PROM is all zeros). The example further assumes

Change 1



MASK MEMAD1	EQU EQU DATA	>FFFE \$ >3456	Define mask Establish memory address for data Enter data in memory location
STRING SETUP	EQU EQU	4 \$	MEMAD1 Define ROM word size Define starting point of setup sequence for programming a PROM word
DATAIN	EQU	>0300	Register select code to load
	LI	RO,DATAIN	Load register select code into R0
	LDCR	R0,0	Transfer Register Select Code to module input register
	LI	R0,MASK	Transfer FFFE to R0
	MOV	@MEMAD1,R1	Transfer 3456 to R1
	LI	R2,STRING	Transfer ROM word size to R2
	MOV	R1,R3	Copy data in R3
CYCLE	EQU	\$	Define start of word programming
OTOLL	LUU	Ψ	loop
	SZC	R0,R1	Use mask (R0) to set all but one bit
	520	nu,n i	in R1 to zeros (inactive)
	SWPB	R1	Put least significant byte of R1
	3001 0		in most significant position
	LDCR	R1,8	Transfer masked data to module input
	LDCN	N1,0	register
			register
	•		Insert sequences to initiate programming
	•		cycle and to allow for duty cycle rest
			period
	SRC	R0,15	Change mask value to enable next
		D0 D4	significant bit position
	MOV	R3,R1	Restore correct data to R1
	DEC	R2	Decrement word size counter
	JNE	CYCLE	If word size has not decremented to
	5011	^	zero, repeat masking cycle.
NEWAD	EQU	\$	If word size has decremented to zero, enter
	•		segment to select new address and data
	•		pattern.
	•		

3.5 READING A ROM

The module can also be used to verify data contained in an existing ROM circuit or in a PROM that has just been programmed with the module. The process is similar to those already described for the programming operation. The address register must be loaded with the address of the ROM word to be read. However, since no data will be transmitted to the ROM, the module data register does not need to be loaded. Also, the register select code bits must all be set to select the read data operation. Addressing a Store CRU operation to the module then

transfers the data from the ROM to the specified computer location. From that location it can be read and printed on a printer or CRT for verification. The following instruction sequence illustrates the steps required to read a ROM word into computer memory (at address $A73_{16}$):

ADDR0 DOUT	EQU EQU	>0100	Register Select Code
DOUT	EUU	>0700	Register Select Code for
ROMAD1	BYTE	>73	reading ROM Least Significant Byte of ROM Address
ROMAD2	BYTE	>0A	Most Significant Byte of ROM Address
	MO∨B	@ROMAD1,R1	Transfer Least Significant Byte to R1
	SRL	R1,8	Shift address to right half of R1
	LI	R0,ADDR0	Load Register Select Code into R0
	MOVB	R0,R1	Transfer code to left half of R1
	LDCR	R1,0	Transfer (R1) to module input register
	SBO	13	Set Load bit
	SBZ	13	Clear Load bit
NXTAD	MOVB	@ROMAD2,R1	Transfer Most Significant Byte to R1
	SRL	R1,8	Shift address to right half of R1
	CLR	RO	Change Register Select Code to
			0000 ₁₆
	MOVB	R0,R1	Transfer Register Select Code
			to RO
	LDCR	R1,0	Transfer (R1) to module input register
	SBO	13	Set Load bit
	SBZ	13	Clear Load bit
	LI	R1,DOUT	Load Register Select Code for reading ROM into R1
	LDCR	R1,0	Transfer (R1) to module input register
	STCR	R1,8	(enables ROM data input to CRU) Load the 8 ROM data bits from the module into R1

3.6 READ MODULE REGISTERS

The three module registers (Address, Data and Pulse Width) can be examined at any time in the program sequence by addressing successive STCR instructions to the module while changing the Register Select Code. The STCR instruction will read the contents of the 8 bits indicated by the Register Select Code and store them in a specified memory area. Therefore, if the Register Select Code already indicates the register that needs to be checked, only an STCR instruction is required. This feature allows each register to be checked immediately after it is loaded merely by using an STCR instruction, since the Register Select Code used to load the register is the same as that used to read from the register. To illustrate the register monitoring process, the following instruction sequence reads the contents of the registers into defined areas of memory so that they can be displayed on a system terminal:

ROMAD1	BYTE	00	Memory for least significant byte
ROMAD2	BYTE	00	of address register Memory for most significant byte of address register

(Listing continued on next page)



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ROMDAT	BYTE	00	Memory for module data register contents
PULSWD CHK	BYTE EQU CLR	00 \$ R1	Memory for Pulse Width contents
	LDCR	R1,0	Clear module input register (Register Select Code = 000_2)
	STCR	ROMAD2,8	Store most significant byte of address register in memory ROMAD2
	SBO	8	Change Register Select Code
	STCR	ROMAD1,8	Store least significant byte of address register in memory ROMAD1
	SBO	9	Change Register Select Code
	STCR	ROMDAT,8	Store Data Register contents in memory ROMDAT
	SBZ	9	
	SBO	10	Change Register Select Code
	STCR	PULSWD,8	Store Pulse Width value in memory PULSWD

SECTION IV

OPERATION

4.1 GENERAL

Operation of the PROM Programming module is controlled by the software interface that is resident in the Model 990 Computer. This interface may be supplied by the user (see Section III of this manual), or it can be ordered from Texas Instruments Incorporated as part of the Prototyping System Software. Because operator interaction with either of these interfaces varies, the operator should consult the documentation for the interface to determine the exact steps required to operate the system. The Prototyping System Software information may be found in the Model 990 Computer Prototyping System Operation Guide. This section provides information for using the module regardless of the controlling software interface.

4.2 CONTROLS AND INDICATORS

The module contains two LED indicators and a key switch that are mounted on the front panel of the module. The personality card for bi-polar PROM devices has a toggle switch located to the right of the three PROM sockets; the personality card for EPROM devices has a toggle switch next to its single socket. Figure 4-1 illustrates the position of each of these components; table 4-1 defines their nomenclature and function.



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4-1

Nomenclature	Device	Function
POWER	Indicator	Lights to indicate that the module power supply is furnishing logic power to the module.
PROGRAMMING	Indicator	Lights to indicate that the module is executing a programming cycle and is applying the programming pulse to the PROM device sockets.
ON/OFF	Key Switch	Enables and disables ac power to the power supply. When in ON position, ac power is applied to the supply to generate all voltage levels required by the module. When in OFF position, ac power is removed from the supply to disable operation. Removing the key from the switch prevents the position from being changed.
C/D*	Toggle Switch	Modifies function of rightmost PROM socket. When set to C, the socket can be used to program 256 x 8 PROMs, device types 74S470 and 74S471. When set to D, the socket can be used to program 512×8 PROMs, device types 74S472 and 74S473.
A*	DIP Socket	Mounts and holds 32 x 8 PROM devices for pro- gramming (device types 74188A, 74S188 and 74S288).
B*	DIP Socket	Mounts and holds 256 x 4 PROM devices for pro- gramming (device types 74S287 and 74S387).
C/D*	DIP Socket	Mounts and holds 256 or 512 x 8 PROM devices for programming (device types 74S470, 74S471, 74S472 and 74S473).
EPROM**	DIP Socket	Mounts and holds EPROM devices for programming (Intel devices 2704 or 2708).
A/B**	Toggle Switch	Modifies function of EPROM DIP socket. When set to B, the socket can be used to program 1024×8 EPROM devices (Intel 2708); when set to A, the socket can be used to program 512 x 8 EPROM (Intel 2704).

Table 4-1. PROM Programming Module Operator Components

*Bi-polar Personality Card **EPROM Personality Card

4.3 MOUNTING AND REMOVING A PROM

In order to program a PROM, it must be properly installed in the correct socket on the front panel of the PROM Programming Module. Perform the following steps to ensure that the PROM is correctly installed:

- 1. Ensure that the PROGRAMMING indicator is not lighted. If it is lighted, wait until it goes out before continuing with procedure.
- 2. Select the socket on the module that corresponds to the device to be programmed. If the wrong personality card is currently installed on module, install the correct personality card using the procedure described later in this section.

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- 3. Position the locking lever of the selected socket so that it points out from the panel. This releases the locking mechanism in the socket.
- 4. Insert the PROM into the socket with pin 1 of the device in the upper left corner of the socket (next to the locking lever).
- 5. Reposition the locking lever so that it points up. This locks the PROM securely in place.
- 6. Ensure that the ON/OFF switch is in the ON position, the POWER indicator is lighted, and that the toggle switch is set properly.
- 7. Initiate the programming cycle (consult the software interface documentation to determine the required preparation and steps to perform the programming cycle).
- 8. When the programming cycle is complete, remove the PROM by positioning the locking lever to release the PROM and lift the PROM from the socket.

4.4 EXCHANGING PERSONALITY CARDS

Each personality card comes in a complete front panel assembly for quick and easy exchange to switch from bi-polar ROMs to erasable PROMs (EPROMs). The following procedure describes the steps required to exchange the cards:

NOTE

When the front panel of the module is removed, an interlock switch removes power from the unit to prevent an electrical shock hazard.

- 1. Grasp the front panel at either side and pull out to remove the panel from the module. The table-top model may have to be held down to remove the front panel.
- 2. Disconnect the ribbon cable connector, the logic power connector and the ac power connector from the front panel assembly.
- 3. Connect the ribbon cable connector to the new personality card and front panel assembly. Ensure that the triangle embossed on the cable connector aligns with the triangle embossed on the personality card connector. The triangle indicates the position of pin 1 for each connector.
- 4. Connect the ac power cable connector to the corresponding connector on the personality card. The shape of the connector pin sleeves prevents them from mating in the wrong orientation. If the connectors will not mate properly, rotate one connector 180 degrees and try again.
- 5. Connect the logic power connector to the corresponding connector on the personality card.
- 6. Ensure that the cables are not caught between the panel assembly and the chassis of the module, and press the new front panel assembly in place on the chassis.



ALPHABETICAL INDEX

INTRODUCTION

The following index lists key words and concepts from the subject material of the manual together with the area(s) in the manual that supply major coverage of the listed concept. The numbers along the right side of the listing reference the following manual areas:

- Sections References to Sections of the manual appear as "Section x" with the symbol x representing any numeric quantity.
- Appendixes References to Appendixes of the manual appear as "Appendix y" with the symbol y representing any capital letter.
- Paragraphs References to paragraphs of the manual appear as a series of alphanumeric or numeric characters punctuated with decimal points. Only the first character of the string may be a letter; all subsequent characters are numbers. The first character refers to the section or appendix of the manual in which the paragraph is found.
- Tables References to tables in the manual are represented by the capital letter T followed immediately by another alphanumeric character (representing the section or appendix of the manual containing the table). The second character is followed by a dash (-) and a number:

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• Figures - References to figures in the manual are represented by the capital letter F followed immediately by another alphanumeric character (representing the section or appendix of the manual containing the figure). The second character is followed by a dash (-) and a number:

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• Other entries in the Index - References to other entries in the index are preceded by the word "See" followed by the referenced entry.

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